

Declaration of Conformity

We declare, under our sole responsibility, that the product listed below fulfills the requirements specified in Regulation (EU) 2017/746 on in-vitro diagnostic (IVD) medical devices.

Manufacturer's Name and Business Address:	Leica Biosystems Melbourne	Pty Ltd
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495 Blackburn Road

Mt Waverley

Victoria 3149, AUSTRALIA

Manufacturer Single Registration Number (SRN): AU-MF-000016740

European Representative: CEpartner4U BV

Esdoornlaan 13 3951 DB Maarn The Netherlands

European Representative Single Registration

Number (SRN): NL-AR-000000111

Product Name: BOND-MAX processing module and

associated components listed in the attached

device Schedule A

Basic UDI-DI: 9349458001D9

Risk Class: Class A – Rule 5 Annex VIII of Regulation

(EU) 2017/746

Conformity Assessment Route: Annex IV, in combination with Annex II and

Annex III

Object of the declaration:



Intended Use: The BOND

The BOND system automates clinical protocols for immunostaining of pathology specimens mounted on microscope slides. Microscope slides subsequently undergo interpretation by a qualified healthcare professional to aid diagnosis.



The object of the declaration described above is in conformity with the relevant Union harmonisation legislation:

Electromagnetic Compatibility (2014/30/EU)

Waste electrical & Electronic Equipment (2012/19/EU)

Restriction on the Use of Certain Hazardous Substance in Electrical & Electronic Equipment (2011/65/EU)

Regulation (EU) 2017/746 on In Vitro

Diagnostic Medical Devices

The following standards and technical documentation have been applied:

EN 61326-1:2013 (IEC 61326-1:2012 Edition 2.0)

EN 61326-2-6:2013 (IEC 61326-2-6:2012 Edition 2.0)

UL/IEC 61010-1, Edition 3.0

IEC 61010-2-010, Edition 3.0

IEC 61010-2-081, Edition 1.1

IEC 61010-2-101 Edition 2.0

Electrical equipment for measurement, control and laboratory use- EMC requirements. Part 1: General requirements. Electrical equipment for measurement, control and laboratory use-EMC requirements- Part 2-6: Particular requirements- In vitro diagnostic (IVD) medical equipment.

Safety requirements for electrical equipment for measurement, control, and laboratory use

Part 1: General requirements

Safety requirements for electrical equipment for measurement, control, and laboratory use Part. 2-010, Particular requirements for laboratory equipment for the heating of materials

Safety requirements for electrical equipment for measurement, control, and laboratory use

Part 2-081: Particular requirements for automatic and semi-automatic laboratory equipment for analysis and other purposes Safety requirements for electrical equipment for measurement, control and laboratory use -Part 2-101: Particular requirements for In vitro

diagnostic (IVD) medical equipment

Signed for and on behalf of:

DocuSigned by:

Sandeep Chollangi

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Signer Name: Sandeep Chollangi Signing Reason: I approve this document Signing Time: 21-Apr-2023 | 15:54:21 AEST

Sandeep Chollangi

RA Manager

Leica Biosystems Melbourne Pty Ltd



SCHEDULE A

Component/Accessory Description	Catalogue Number	
BOND-MAX Processing Module	49.0051	
BOND System Control Kit (6.0/W10 IoT) containing:	21.2793	
BOND System Control Kit (7)	49.0644	
BOND Controller (6.0/W10 IoT)	S21.4621	
BOND Controller (7)	S49.4524	
BOND-ADVANCE Terminal (6.0/W10 loT)	S21.4622	
BOND-ADVANCE Terminal (7)	49.4525	
BOND-ADVANCE Controller (6.0)	S21.4623	
BOND-ADVANCE Controller (7)	49.4526	
BOND Universal Covertiles (pack of 160)	S21.4611	
BOND Universal Covertiles – 100 Pack	S21.2001	
BOND Slide Labels and Printing Ribbon	S21.4564	
BOND Cognitive Slide Labeller	S21.4605	
BOND Printer Ribbon & Labels Cxi (1 Pack)	S21.4604	
BOND Printer Ribbon & Labels Cxi (6 Pack)	S21.4610	
BOND Handheld Barcode Scanner	S21.2802	
BOND Mixing Stations (5 pack)	S21.1971	
Zebra GX430t Label Printer Spare	S21.4615	

Revision No.	Date	Summary of Changes
A01	18 Feb 2022	Initial release and date of first compliance with (EU) 2017/746
A02	21 April 2023	Update to include the intended use